查<u>询"FDD5N50NZ"</u>供应商

FAIRCHILD

SEMICONDUCTOR

FDD5N50NZ N-Channel MOSFET 500V, 4A, 1.5Ω

Features

- $R_{DS(on)} = 1.38\Omega$ (Typ.)@ $V_{GS} = 10V$, $I_D = 2A$
- Low Gate Charge (Typ. 9nC)
- Low C_{rss} (Typ. 4pF)
- Fast Switching
- 100% Avalanche Tested
- Improved dv/dt Capability
- ESD Imoroved Capability
- RoHS Compliant



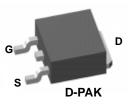
November 2009 UniFET-II[™]

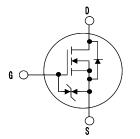
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Description

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology.

This advance technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficient switching mode power supplies and active power factor correction.





MOSFET Maximum Ratings T_C = 25°C unless otherwise noted*

Symbol		FDD5N50NZ	Units		
V _{DSS}	Drain to Source Voltage			500	V
V _{GSS}	Gate to Source Voltage			±25	V
I _D	Drain Current	-Continuous (T _C = 25 ^o C)		4	- A
		-Continuous ($T_C = 100^{\circ}C$)		2.4	
I _{DM}	Drain Current	- Pulsed	(Note 1)	16	A
E _{AS}	Single Pulsed Avalanche Energy		(Note 2)	304	mJ
I _{AR}	Avalanche Current		(Note 1)	4	A
E _{AR}	Repetitive Avalanche Energy		(Note 1)	6.2	mJ
dv/dt	Peak Diode Recovery dv/dt		(Note 3)	10	V/ns
P _D	Power Dissipation	$(T_{C} = 25^{\circ}C)$		62	W
		- Derate above 25°C		0.5	W/ºC
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C	
TL	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds			300	°C

Thermal Characteristics

Symbol	Parameter	FDD5N50NZ	Units	
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case		°C/W	
R_{\thetaJA}	Thermal Resistance, Junction to Ambient	90	-0/10	

Device MarkingDeviceFDD5N50NZFDD5N50NZTM		Package	Reel	Size	Таре	Width		Quantit	У	
		D-PAK			6mm		2500			
Electrica	l Chai	racteristics T _c = 2	25°C unless of	erwise noted						
Symbol		Parameter		Test Co	nditions		Min.	Тур.	Max.	Units
Off Charac	teristic	s	I							
BV _{DSS}		o Source Breakdown Vol	tage I	_D = 250μA, V _{GS} =	0V, T _{.1} =	25°C	500	-	-	V
ΔBV _{DSS} ΔTJ	Breakdown Voltage Temperature Coefficient		<u>ъ</u>	$I_D = 250\mu A$, Referenced to $25^{\circ}C$		-	0.5	-	V/°C	
			N N	$V_{DS} = 500V, V_{GS} = 0V$ $V_{DS} = 400V, T_{C} = 125^{\circ}C$			-	-	1	
DSS			N V				-	-	10	μA
I _{GSS}	Gate to Body Leakage Current		V	$V_{GS} = \pm 25V, V_{DS} = 0V$		-	-	±10	μA	
On Charac	teristic	S								
V _{GS(th)}	Gate Threshold Voltage		١	$V_{GS} = V_{DS}, I_{D} = 250 \mu A$		3.0	-	5.0	V	
R _{DS(on)}	Static Drain to Source On Resistance			$V_{GS} = 10V, I_D = 2A$		-	1.38	1.5	Ω	
9 _{FS}	Forward Transconductance			$V_{\rm DS} = 20V, I_{\rm D} = 20V$	2A	(Note 4)	-	3.54	-	S
C _{iss} C _{oss}	Characteristics Input Capacitance Output Capacitance			/ _{DS} = 25V, V _{GS} = = 1MHz	0V		-	330 50	440 70	pF pF
C _{rss}		Reverse Transfer Capacitance				-	4	6	pF	
Q _{g(tot)}		Total Gate Charge at 10V Gate to Source Gate Charge		$V_{DS} = 400V I_D = 4A$ $V_{GS} = 10V$		-	9	12	nC	
Q _{gs}	Gate to					-	2	-	nC	
Q _{gd}	Gate to	Drain "Miller" Charge		(Note 4, 5)		-	4	-	nC	
Switching	Charac	teristics								
t _{d(on)}	Turn-O	n Delay Time					-	12	35	ns
t _r	Turn-O	n Rise Time		′ _{DD} = 250V, I _D = 4			-	22	55	ns
t _{d(off)}	Turn-O	ff Delay Time	\ \	$V_{GS} = 10V, R_G = 25\Omega$			-	28	65	ns
t _f	Turn-Off Fall Time			(Note 4, 5)		-	21	50	ns	
Drain-Sou	rce Dio	de Characteristics								
Is	Maximum Continuous Drain to Source Diod			orward Current			-	-	4	Α
I _{SM}	Maximu	m Pulsed Drain to Source	ce Diode Forwa	orward Current			-	-	16	Α
V _{SD}	Drain to	Source Diode Forward	Voltage V	$V_{GS} = 0V, I_{SD} = 4A$			-	-	1.4	V
t _{rr}	Reverse	e Recovery Time	٧	$I_{GS} = 0V, I_{SD} = 4/$	4		-	315	-	ns
	Reverse Recovery Charge			$I_F/dt = 100A/\mu s$		(Note 4)	-	1.8	-	μC

Notes: 1. Repetitive Rating: Pulse width limited by maximum junction temperature

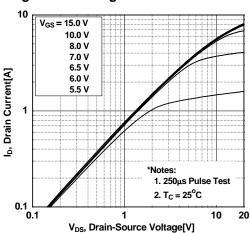
2. L = 38mH, I_{AS} = 4A, V_{DD} = 50V, R_G = 25\Omega, Starting T_J = 25^{\circ}C

3. $I_{SD} \leq 4A, \, di/dt \leq 200A/\mu s, \, V_{DD} \leq BV_{DSS}, \, Starting \, T_J$ = $25^{\circ}C$

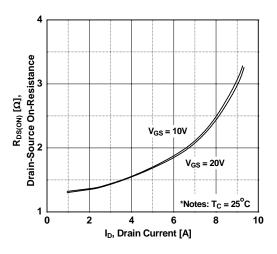
4. Pulse Test: Pulse width $\leq 300 \mu s,$ Dual Cycle $\leq 2\%$

5. Essentially Independent of Operating Temperature Typical Characteristics

查询"FDD5N50NZ"供应商 Typical Performance Characteristics Figure 1. On-Region Characteristics









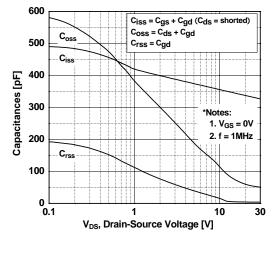
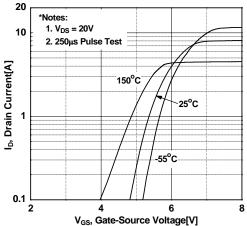
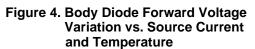


Figure 2. Transfer Characteristics





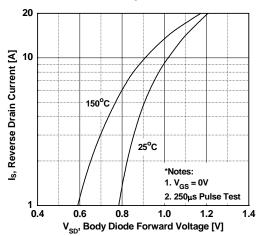
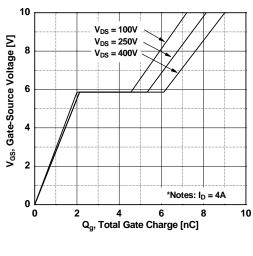
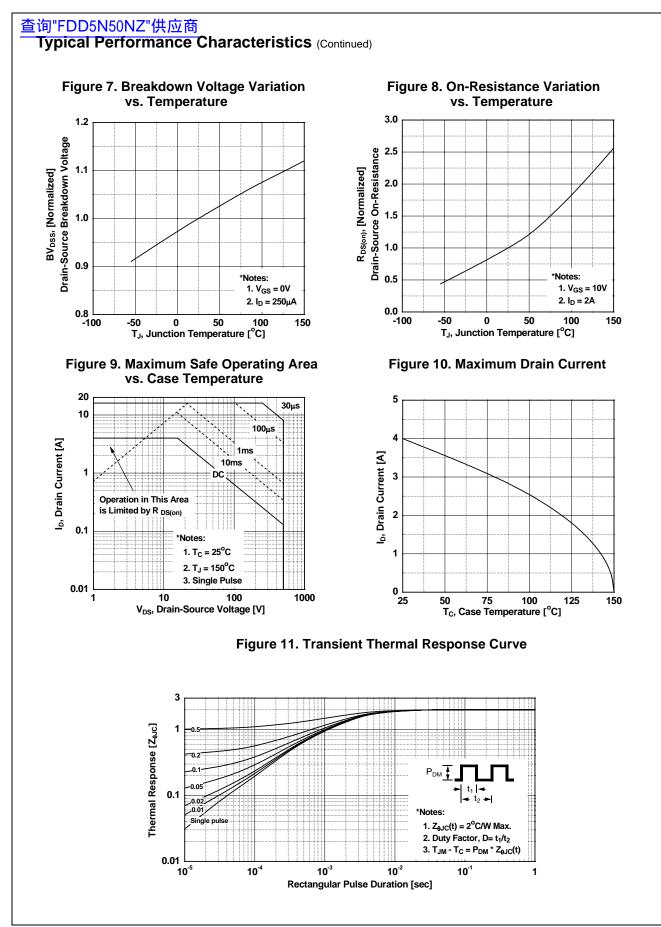
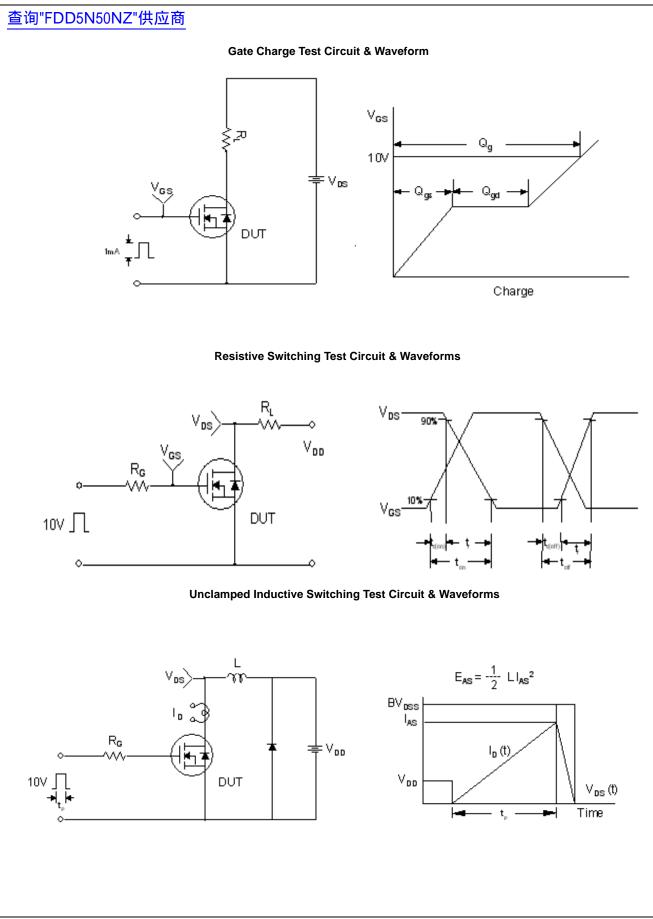


Figure 6. Gate Charge Characteristics





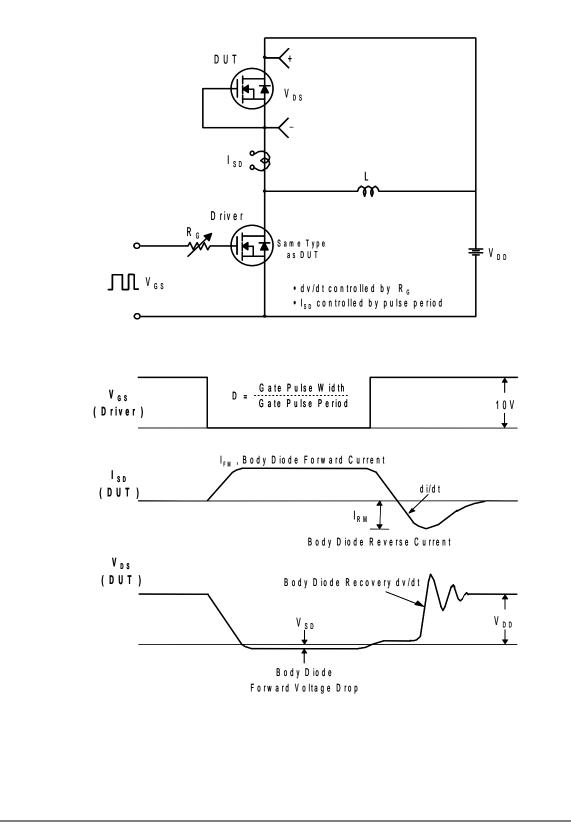
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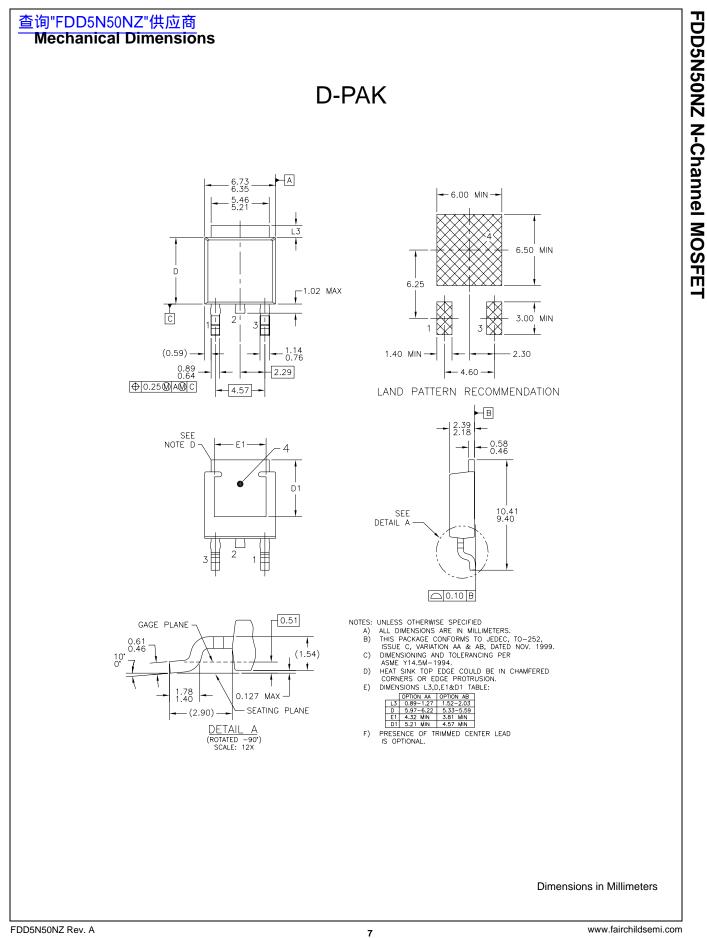


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Peak Diode Recovery dv/dt Test Circuit & Waveforms





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